

EPIC® H-DD 42

The H-DD series with machined crimp contacts - for a high number of pin in very tight spaces.

The connector insert is designed for a high number of pins in a small area, which means it is possible to use a smaller housing design.

Info

Highest packing density for compact connectors







Mechanical and plant engineering



Space requirement

Benefits

The H-DD series with machined contacts is designed for a high number of pins in very tight spaces. This allows for smaller housing types to be chosen.

Application range

Mechanical engineering Light & sound technology Plastics industry

Technical Data

Classification ETIM 5: ETIM 5.0 Class-ID: EC000438

ETIM 5.0 Class-Description: Contact insert for industrial

ETIM 6.0 Class-ID: EC000438 Classification ETIM 6:

ETIM 6.0 Class-Description: Contact insert for industrial

connectors

IEC: 250 V Rated voltage (V):

UL: 600 V

Last Update (31.12.2023) ©2023 Lapp Group - Technical changes reserved Product Management www.lappkabel.de You can find the current technical data in the corresponding data sheet. PN 0456 / 02_03.16





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CSA: 600 V

Rated impulse voltage: 2.5 kV

Rated current (A): IEC: 10 A

UL: 8.5 A CSA: 10 A

Pollution degree: 2

Contact resistance: < 3 mOhm

Contacts: Copper alloy, hard silver/gold-plated

Number of contacts: 42 + PE

Termination methods: Crimp termination: 0.14 - 2.5 mm²

Cycle of mechanical operation: 100

VDE-tested: Certified production control: VDE-REG. no.: B437

UL-tested:

UL File Number: E75770

Temperature range: -40 °C to +100 °C, short-term up to +125 °C

Note

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Article number	Article description	Contact type	Article designation	Number of operating contacts	Pieces / PU
H-DD 42 crimp termination					
11285100	H-DD 42 SCM	male	machined	1 - 42	5
11286100	H-DD 42 BCM	female	machined	1 - 42	5